



Selective steam reforming of methanol over silica-supported copper catalyst prepared by sol–gel method

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ARTICLE INFO

Article history:

Received 31 March 2008

Received in revised form 11 August 2008

Accepted 14 August 2008

Available online 22 August 2008

Keywords:

Methanol steam reforming

Copper supported on silica

Sol–gel method

CO formation

X-ray diffraction

X-ray photoelectron spectroscopy

ABSTRACT

Silica-supported copper prepared by a sol–gel method can selectively catalyze methanol steam reforming to hydrogen and carbon dioxide at 250 °C. The catalytic activity increases with the copper content up to 40 wt.%. The selectivity to carbon monoxide with the catalysts containing 20–40 wt.% of copper is significantly lower than that with a commercial Cu/ZnO/Al₂O₃ catalyst. Copper particles are highly dispersed in the catalyst whose Cu content is 20 wt.% or less. After the reaction at 250 °C the particles are present as Cu₂O with the mean crystallite size less than 4 nm. In the catalyst with the Cu content of 30–50 wt.%, the fine Cu₂O particles coexist with large metallic Cu particles whose mean crystallite size is 30–40 nm after the reaction. The large metallic particles are supposed to contribute to the reaction as well as the fine Cu₂O particles although the surface area is estimated to be significantly smaller than that of the latter.

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1. Introduction

The hydrogen production by steam reforming of methanol is one of the key issues for the development of fuel cell powered devices such as electric vehicles. Polymer electrolyte fuel cells (PEFCs) are generally employed for the mobile applications while the hydrogen fuel must not contain carbon monoxide above 10 ppm, which poisons the catalytic anode [1]. Copper catalysts such as Cu/ZnO/Al₂O₃ are usually selective in the steam reforming to hydrogen and carbon dioxide ($\text{CH}_3\text{OH} + \text{H}_2\text{O} \rightarrow 3\text{H}_2 + \text{CO}_2$), but additional reactors are required in the fuel processor system to remove by-produced carbon monoxide to the level less than 10 ppm [2]. Selective oxidation of carbon monoxide is often carried out to remove carbon monoxide from the reforming gas [1], although an excessive amount of oxygen is required in the process. Hence, high CO concentration causes loss of hydrogen and additional reactors to the reformer. Membrane separation of hydrogen is attractive because pure hydrogen is obtained through a pinhole-free palladium membrane [3]. However, defects usually exist on thin membranes and they decrease the selectivity ratio of hydrogen to other gases. For example, when the ratio is as high as 1000 and the CO concentration in the reforming gas is 1.2%, which is produced in the reforming with

steam/methanol molar ratio of 1.5 under the equilibrium at 250 °C and at 1 MPa, 18 ppm of carbon monoxide is still present in the permeated hydrogen. This insufficient CO concentration requires addition of CO removal process such as methanation ($\text{CO} + 3\text{H}_2 \rightarrow \text{CH}_4 + \text{H}_2\text{O}$) to the hydrogen processor for PEFC. Hence, prevention of CO by-production is important for simplification of the system even if it equips a hydrogen permeable membrane.

Agrell et al. reported that CO by-production is caused by the reverse water–gas shift reaction ($\text{CO}_2 + \text{H}_2 \rightarrow \text{CO} + \text{H}_2\text{O}$) in the methanol steam reforming over Cu/ZnO/Al₂O₃, which is also active to the reverse water–gas shift reaction [4]. Copper supported on silica is also active to the methanol steam reforming [5], while the activity toward water–gas shift reaction is sensitive to the structure such as the particle size of copper [6]. Since copper particles can be highly dispersed in Cu/SiO₂ prepared by a sol–gel method [7], we have employed the sol–gel method in preparation of Cu/SiO₂ with the Cu content up to 50 wt.% and examined the activity to the methanol steam reforming. Here, it is shown that the selectivity to carbon monoxide is low in the reaction over the Cu/SiO₂ catalysts at 250 °C.

2. Experimental

Silica-supported copper catalysts ($x\text{-Cu/SiO}_2$, x represents the copper content in wt.%) were prepared by the hydrolysis and

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polymerization of a mixture of tetramethoxy silane (Tokyo Chemical Industry), copper nitrate (Wako, S-grade), water, and methanol at room temperature for 1 day. After drying in air at 120 °C they were heated in air for 5 h at 500 °C for removal of NO_3^- anions and residual organic compounds. A commercial $\text{Cu/ZnO/Al}_2\text{O}_3$ catalyst (Süd-Chemie, MDC-3), which is reported to be durable in the reaction even at 350 °C [8], was used as a reference.

Catalytic tests were performed in a fixed-bed continuous-flow reactor operated under atmospheric pressure. A catalyst (0.50 g, granules of 10–20 mesh) was placed in a tube reactor made of stainless steel (i.d., 7 mm). After the pre-reduction in a stream of 15 vol.% hydrogen diluted with argon ($3.5 \text{ dm}^3 \text{ h}^{-1}$) at a desired temperature for 1 h, a mixture of methanol, steam, and argon (1.0/1.5/1.0 in molar ratio) was introduced at 250 or 300 °C with a flow rate of $10.6 \text{ dm}^3 \text{ h}^{-1}$. The effluent gas was dried with a cold trap at ca. –50 °C, and analyzed with an on-stream gas chromatograph (Shimadzu GC-8A; activated carbon, 2 m; Ar carrier) equipped with a thermal conductivity detector. The methanol conversion was determined from the material balance of the reactant and the products, and the error was within 5%. No formation of formaldehyde, methane or methyl formate was observed.

The BET surface areas of the catalysts were determined from the isotherms of nitrogen physisorption.

Powder XRD (X-ray diffraction) patterns of the catalysts were recorded in air at room temperature with an MAC Science MP6XCE diffractometer using nickel-filtered $\text{Cu K}\alpha$ radiation. The Rietveld refinement of the patterns was carried out using the Rietveld software RIETAN-2000 [9]. To obtain the quantitative phase abundance, the XRD data of 30–70° in two theta were modeled with monoclinic CuO (space group, C2/c), cubic Cu_2O (Pn-3m), and cubic Cu (Fm-3m) using a pseudo-Voigt function. The factor of R_{wp} was always less than 5%.

X-ray photoelectron spectra (XPS) were recorded at room temperature with a JEOL JPS-9010MX spectrometer ($\text{Mg K}\alpha$). The sample was taken out from the reactor after cooling under an argon stream for 12 h or longer and mounted in air to a sample holder. Binding energies were corrected by the reference of the C 1s line at 284.6 eV. The surface atomic concentrations of Cu, Si, and O were calculated from the peak areas using the atomic relative sensitivity factors (ARSF) of Cu 2p_{3/2} (13), Si 2p (1.0), and O 1s (2.4) determined by measuring standard materials of copper plate, silicon wafer, and quartz glass plate. The concentration analysis using ARSF is quantitative and the uncertainty is less than 2% [10].

Temperature-programmed reduction (TPR) of the catalyst (0.50 g) was carried out in a stream of 15 vol.% hydrogen diluted with argon at a flow rate of $3.5 \text{ dm}^3 \text{ h}^{-1}$. Temperature of the sample bed was risen linearly at a rate of 200°C h^{-1} . The hydrogen consumption was monitored by analyzing the hydrogen concentration with the on-stream GC every 3 min. No complete hydrogen consumption was observed in the reduction.

3. Results

3.1. Methanol steam reforming over silica-supported copper

Steam reforming of methanol was carried out over the silica-supported copper catalyst. Hydrogen and carbon dioxide were almost quantitatively formed at 250 °C, while a small amount of carbon monoxide was by-produced. The activity of the catalyst pre-reduced at 250 °C increased with an increase in the copper content up to 40 wt.%, but decreased at 50 wt.% (Fig. 1). Interestingly, the selectivity to carbon monoxide was reversely decreased to 0.10% at 40 wt.%. The activity at 250 °C gradually decreased with the time-on-stream, but the decrease was not obvious after 4 h on-stream (Fig. 2). The activity of a commercial

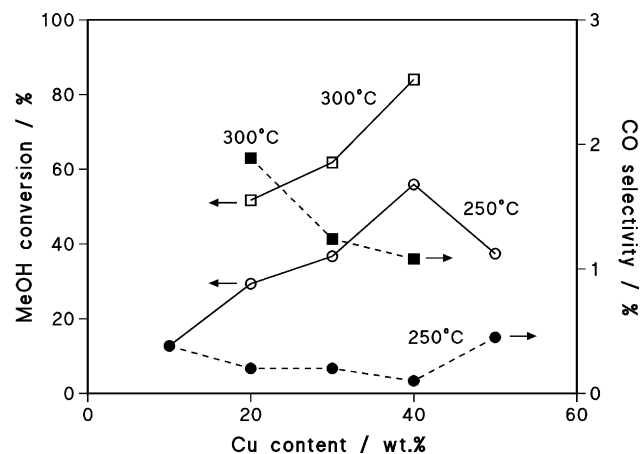


Fig. 1. Catalytic activity of Cu/SiO_2 prepared by a sol-gel method in methanol steam reforming after 6 h. Pre-reduction temperatures are the same as the reaction temperatures shown in the figure.

$\text{Cu/ZnO/Al}_2\text{O}_3$ catalyst at 250 °C was significantly lower than that of 40- Cu/SiO_2 , and the selectivity to carbon monoxide was as high as 0.47%. The pre-reduction temperature of 40- Cu/SiO_2 affected its activity and selectivity. That is, the higher pre-reduction temperature of 300 or 400 °C caused less activity. It is noteworthy that no carbon monoxide was detected in the products, showing that the selectivity to carbon monoxide was less than 0.03% (Fig. 3). The activity of $\text{Cu/ZnO/Al}_2\text{O}_3$ increased appreciably with an increase in the reduction temperature, but the CO selectivity also increased.

When the reaction was carried out at 300 °C, the activities of Cu/SiO_2 increased in parallel manner with those at 250 °C (see Fig. 1). The activity decreased gradually with an increase in the time-on-stream (see Fig. 2). For example, the methanol conversion with 40- Cu/SiO_2 pre-reduced at 300 °C was 95% at 1 h-on-stream and it was 84% at 6 h-on-stream. The selectivity of carbon monoxide was 1.1% throughout the reaction. When a double amount of the catalyst was used, the conversion was 97% at 1 h-on-stream and the CO selectivity increased to 2.0%. In the case of $\text{Cu/ZnO/Al}_2\text{O}_3$ at 300 °C, the selectivity to carbon monoxide was 1.1%, but the activity was considerably lower than that of 40- Cu/SiO_2 (see Fig. 2).

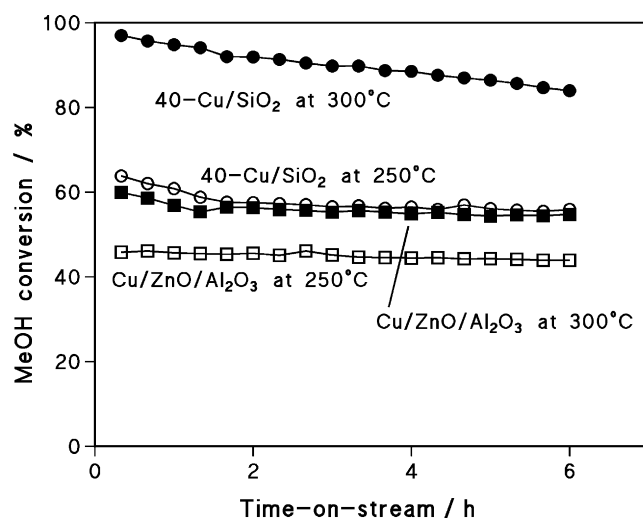


Fig. 2. Comparison of the catalytic activity of 40- Cu/SiO_2 to that of a commercial $\text{Cu/ZnO/Al}_2\text{O}_3$. Pre-reduction temperatures are the same as the reaction temperatures shown in the figure.

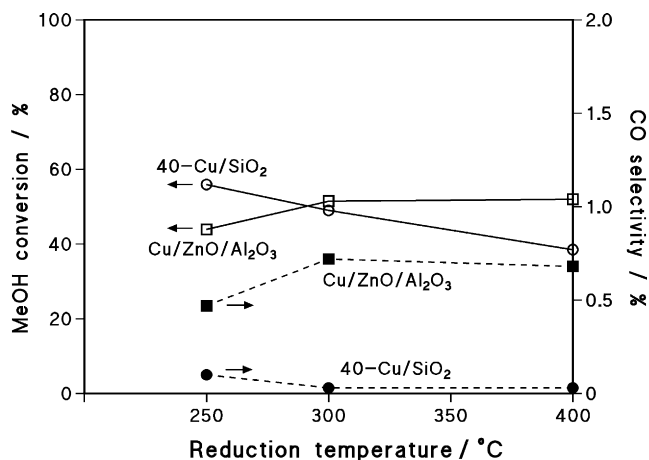


Fig. 3. Catalytic activity of 40-Cu/SiO₂ and Cu/ZnO/Al₂O₃ with different reduction temperatures in the reaction at 250 °C after 6 h.

3.2. Physical properties of catalysts after reaction

A weak peak at 43.3° in 2θ assigned to Cu(1 1 1) was recorded with a slight peak at 37° assigned to Cu₂O(1 1 1) in the XRD pattern for 10-Cu/SiO₂ just after reduction at 250 °C (Fig. 4a) [11]. After the reaction at 250 °C a broad peak at 36.7° assigned to Cu₂O(1 1 1) was recorded with a slight peak at 42° assigned to Cu₂O(2 0 0) in the XRD pattern (Fig. 4b) [11]. The peaks attributed to Cu₂O were intensified in the pattern for 20-Cu/SiO₂ with a very small peak at 43.4°. The pattern changed drastically when the Cu content was 30 wt.% or above, that is, the peaks at 43.4° and 50.5° attributed to metallic copper appeared clearly with a weak peak at 36.7° attributed to Cu₂O. Mean crystallite sizes were determined from the line broadening of the XRD peaks of Cu(1 1 1) and Cu₂O(1 1 1) using Scherrer equation [12]; in the cases of metal or metal oxide particles dispersed on supports, the crystallite size is usually close to the mean particle size [13,14]. The crystallite sizes for metallic copper particles on Cu/SiO₂ containing 30–50 wt.% Cu were 31–39 nm, and those for Cu₂O were 4–7 nm for the catalysts containing 10–50 wt.% Cu (Table 1). The atomic ratios of Cu in

Table 1

Physical properties of the catalysts after methanol steam reforming at 250 °C for 6 h

Catalyst	Reduction temperature (°C)	BET surface area (m ² g ⁻¹)	Crystallite size (nm)	
			Cu ₂ O	Cu
10-Cu/SiO ₂ ^a	250		3	5
10-Cu/SiO ₂	250	292	4	–
20-Cu/SiO ₂	250	376	4	–
30-Cu/SiO ₂	250	345	5	34
40-Cu/SiO ₂	250	345	5	31
40-Cu/SiO ₂	300	320	4	36
40-Cu/SiO ₂	400	341	4	36
40-Cu/SiO ₂ ^a	400		–	37
40-Cu/SiO ₂ ^b	300	316	4	32
50-Cu/SiO ₂	250	250	7	39
50-Cu/SiO ₂ ^a	250		–	39

^a Just after reduction with hydrogen.

^b After reaction at 300 °C for 6 h.

Cu₂O to that in Cu metal determined by the Rietveld analysis were 0.3 for 30-Cu/SiO₂, 0.3 for 40-Cu/SiO₂, and 0.07 for 50-Cu/SiO₂.

The XRD peak at 36.7° assigned to Cu₂O(1 1 1) was insignificant with 40-Cu/SiO₂ just after the reduction at 400 °C, while the peak was present in the pattern for the catalyst after the reaction regardless of the pre-reduction temperature (Fig. 5). The crystallite size of metallic copper for 40-Cu/SiO₂ pre-reduced at 300 or 400 °C after the reaction at 250 °C was discernibly larger than that pre-reduced at 250 °C (see Table 1).

The BET surface areas for the catalysts after the reaction at 250 °C were 250–376 m² g⁻¹ (see Table 1).

3.3. XPS of the copper catalysts after the reaction

The surface of Cu/SiO₂ after the reaction at 250 °C was characterized by XPS. The binding energy of Cu 2p_{3/2} for 10-Cu/SiO₂ was 933.2 eV and appreciably higher than 932.4 eV attributed to metallic copper or Cu₂O (Fig. 6a and Table 2) [15]. In order to identify the electronic state, the Auger line of Cu L₃VV was recorded (Fig. 7a). The kinetic energy was 915.5 eV which is lower than that for Cu₂O at 916.8 eV [15]. The energy for Cu metal is 918.7 eV [15]. The α value (Auger parameter + photon energy) was 1848.7 eV being lower than 1849.4 eV for Cu₂O and 1851.3 eV for

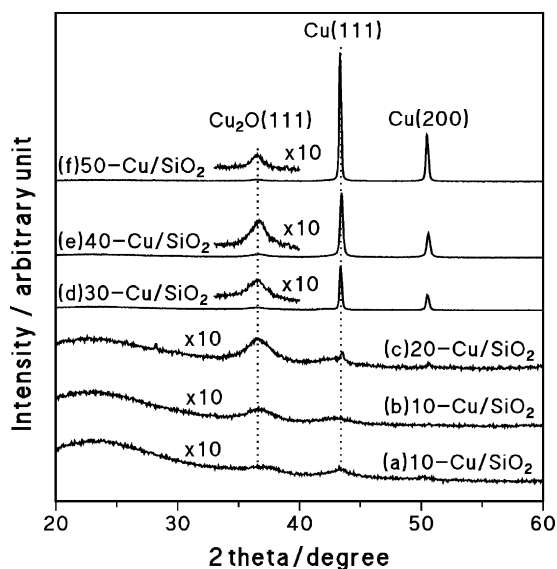


Fig. 4. XRD patterns of Cu/SiO₂. (a) 10-Cu/SiO₂ reduced at 250 °C and (b–f) Cu/SiO₂ after the reaction at 250 °C for 6 h following the reduction at 250 °C.

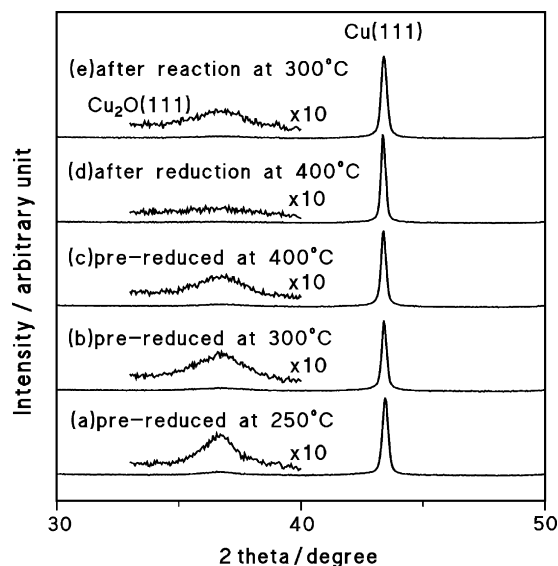


Fig. 5. XRD patterns of 40-Cu/SiO₂. (a–c) After the reaction at 250 °C, (d) just after the reduction at 400 °C, and (e) after the reaction at 300 °C following the reduction at 300 °C.

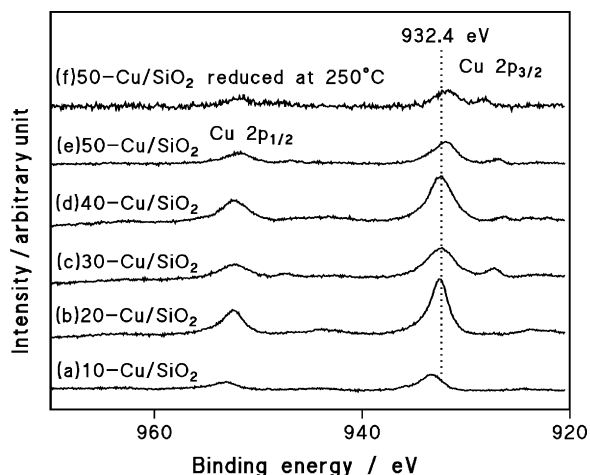


Fig. 6. XPS of Cu 2p region for Cu/SiO₂. (a–e) After the reaction at 250 °C following the reduction at 250 °C, and (f) after the reduction at 250 °C.

metallic copper, while the α value for CuO is 1851.7 eV [15]. The α value for 10-Cu/SiO₂ just after reduction at 250 °C was 1849.6 eV and significantly higher than that for the catalyst after the reaction (see Table 2). The energy of Cu 2p_{3/2} for 20-Cu/SiO₂ was 932.4 eV and the α value was 1849.2 eV, showing presence of Cu₂O on the surface. The similar values were recorded with 30, 40, and 50-Cu/SiO₂ (see Table 2). The α value for 50-Cu/SiO₂ just after the reduction with hydrogen at 250 °C was 1850.5 eV that is in the middle of those for Cu₂O and metallic copper.

The pre-reduction temperatures of 250–400 °C did not significantly affect the energies of Cu 2p_{3/2} and Cu L₃VV for 40-Cu/SiO₂, while the Auger line just after the reduction at 400 °C was at 918.0 eV (Figs. 8 and 9). The binding energy of Cu 2p_{3/2} for 40-Cu/SiO₂ after the reaction at 300 °C following the reduction at 300 °C was discernibly higher than that after the reaction at 250 °C, while the α values were close to each other (see Table 2).

The α value for 40-Cu/SiO₂ just after the reduction at 400 °C was 1850.5 eV, which is the same as that for 50-Cu/SiO₂ reduced at 250 °C.

The binding energies of O 1s and Si 2p were 533.0 ± 0.1 and 103.4 ± 0.2 eV, respectively, regardless of the samples. The surface atomic composition of Cu, Si, and O is also given in Table 2.

3.4. TPR of copper catalysts

Reduction of Cu/SiO₂ catalysts started at ca. 150 °C in TPR experiments regardless of the Cu content (Fig. 10). The maxima of

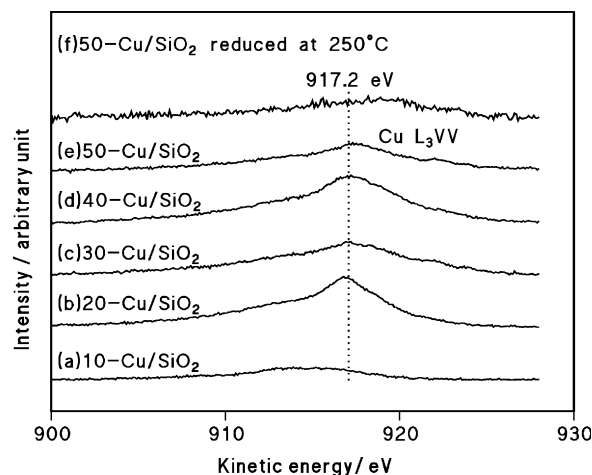


Fig. 7. Auger line of Cu L₃VV for Cu/SiO₂. (a–e) After the reaction at 250 °C following the reduction at 250 °C, and (f) after the reduction at 250 °C.

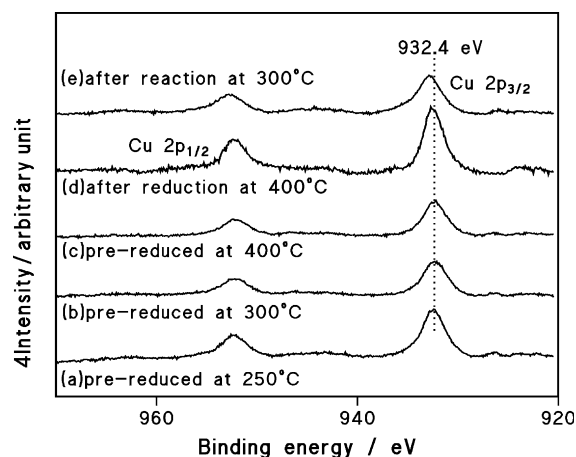


Fig. 8. XPS of Cu 2p region for 40-Cu/SiO₂. (a–c) After the reaction at 250 °C, (d) just after the reduction at 400 °C, and (e) after the reaction at 300 °C following the reduction at 300 °C.

the reduction peaks for 10 and 20-Cu/SiO₂ were at around 190 °C, but another peak was present at around 230 °C in the profile of 30-Cu/SiO₂. Broad peaks were observed at around 200 and 210 °C with 40 and 50-Cu/SiO₂, respectively. The molar amounts of

Table 2

Summary of the XPS data for the catalysts after methanol steam reforming at 250 °C for 6 h

Catalyst	Reduction temperature (°C)	Cu 2p _{3/2} (eV)	Cu L ₃ VV (eV)	α (eV)	Surface atomic composition (%)		
					Cu	Si	O
10-Cu/SiO ₂	250	933.2	915.5	1848.7	2	25	73
10-Cu/SiO ₂ ^a	250	933.2	916.4	1849.6	2	25	73
20-Cu/SiO ₂	250	932.4	916.8	1849.2	5	19	76
30-Cu/SiO ₂	250	932.4	917.0	1849.4	4	21	75
40-Cu/SiO ₂	250	932.4	917.1	1849.5	6	18	76
40-Cu/SiO ₂	300	932.4	917.2	1849.6	4	21	75
40-Cu/SiO ₂	400	932.3	917.2	1849.5	4	23	73
40-Cu/SiO ₂ ^a	400	932.5	918.0	1850.5	5	22	73
40-Cu/SiO ₂ ^b	300	932.7	916.9	1849.6	5	20	75
50-Cu/SiO ₂	250	932.1	917.4	1849.5	2	25	73
50-Cu/SiO ₂ ^a	250	931.8	918.7	1850.5	3	21	76

^a Just after reduction with hydrogen.

^b After reaction at 300 °C for 6 h.

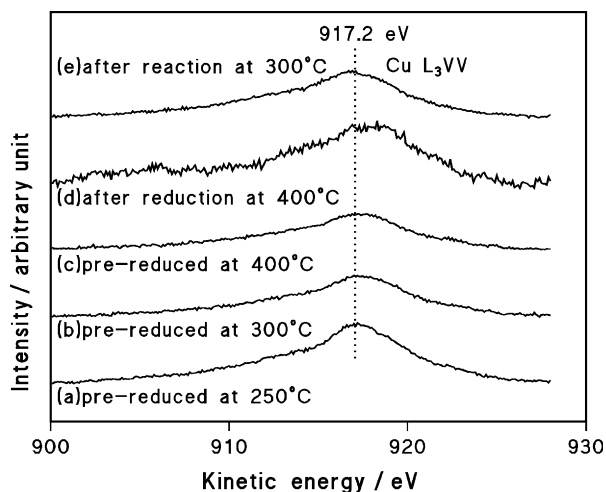


Fig. 9. Auger line of Cu L₃VV for 40-Cu/SiO₂. (a–c) After the reaction at 250 °C, (d) just after the reduction at 400 °C, and (e) after the reaction at 300 °C following the reduction at 300 °C.

hydrogen consumed corresponded well to the molar contents of copper in the catalysts, showing complete reduction of CuO in the catalysts.

The XRD peaks in the pattern of 50-Cu/SiO₂ as prepared were attributed to CuO (Fig. 11a), while the mean crystallite size was 24 nm on the basis of the line broadening of the peak at 48.8° [12]. In a TPR experiment, 50-Cu/SiO₂ was reduced up to 170 °C and quenched under an argon stream, while ca. 1 mmol g⁻¹ of H₂ was consumed. Small peaks attributed to metallic Cu were recorded in the XRD pattern of the sample after the reduction up to 170 °C (Fig. 11b). The mean crystallite size of Cu was 29 nm. The H₂ consumption was ca. 3 mmol g⁻¹ in the reduction up to 200 °C followed by quenching. The intensity of the XRD peaks attributed to metallic copper increased in the pattern for the sample (Fig. 11c), but the peaks attributed to CuO were major. The mean crystallite size of Cu was 34 nm. The molar fractions of Cu/(Cu + CuO) determined by the Rietveld analysis were 4 and 15% in the reduction up to 170 and 200 °C, respectively. Only the peaks attributed to metallic copper were recorded in the XRD pattern for the sample reduced at 250 °C for 1 h, while the mean crystallite size was 39 nm (Fig. 11d).

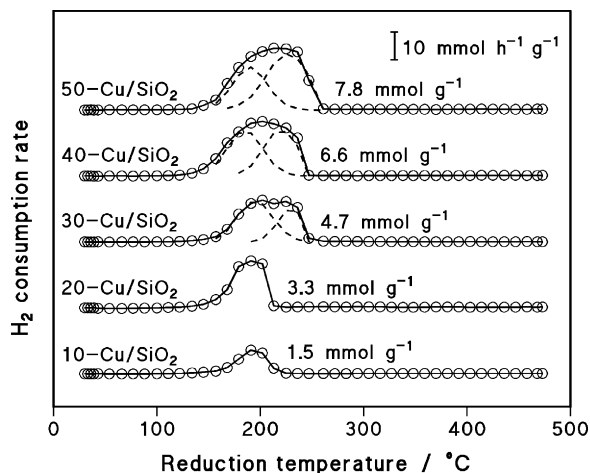


Fig. 10. Profiles of temperature-programmed reduction for Cu/SiO₂ with the heating rate of 200 °C h⁻¹. Total consumption amounts of H₂ are given in the figure.

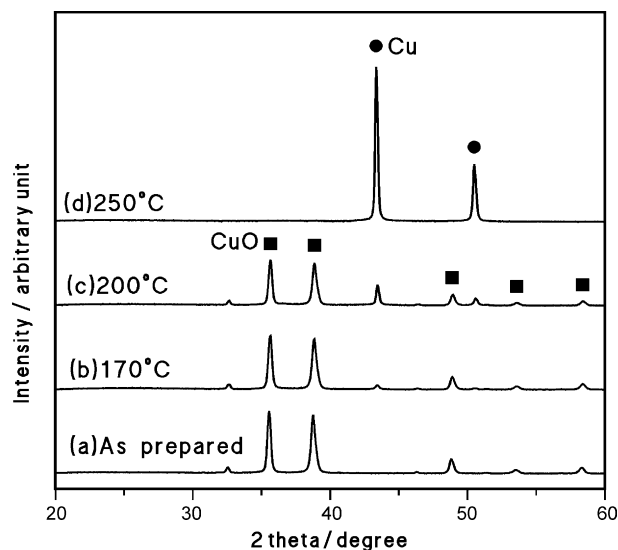


Fig. 11. XRD of 50-Cu/SiO₂. (a) As prepared, (b) reduced up to 170 °C in TPR, (c) reduced up to 200 °C in TPR, and (d) reduced at 250 °C for 1 h.

4. Discussion

4.1. State of Cu particles on Cu/SiO₂ prepared by sol–gel method

The XRD patterns for 10-Cu/SiO₂ after the reduction with hydrogen at 250 °C (see Fig. 4a) shows presence of Cu₂O and metallic Cu. Since the TPR result evidences almost complete reduction of the catalyst by heating up to 250 °C, the fine Cu particles are partly oxidized to Cu₂O during the handling in air. On the other hand, no metallic Cu can be seen in the pattern of the catalyst after the reaction for 6 h (see Fig. 4b). Hence, the oxidation state of the catalyst after the reaction is different from that just after the reduction, and it is suggested that at least the major part of the fine Cu particles is already oxidized in the reaction. In the XPS analysis the α value usually depends on the oxidation state of copper [15]. Since the value for 10-Cu/SiO₂ just after the reduction is lower than that of metallic copper, it is evident that the Cu surface is oxidized in air. However, the α value for the catalyst after the reaction is significantly lower than that after the reduction at 250 °C (see Table 2), showing that the degree of oxidation after the reaction is deeper than just after the reduction. Thus, the XPS result agrees that the surface of the fine Cu particles is already oxidized during the reaction. It is known that metallic nickel particles are oxidized on a silica support in the steam reforming of methane at 500 °C [16], suggesting that silica can promote oxidation of metallic particles in the presence of steam.

In the cases of 30-, 40- and 50-Cu/SiO₂, the XRD patterns show coexistence of Cu₂O and metallic Cu after the reaction (see Figs. 4 and 5), but the α values are close to that of Cu₂O (see Table 2). The values are not mainly due to the oxidation of the metallic Cu particles with the handling in air because the values for the catalysts just after the reduction are significantly higher than those after the reaction.

The XRD pattern of 30-Cu/SiO₂ evidences presence of fairly large Cu particles (see Fig. 4d). The TPR profile for 30-Cu/SiO₂ can be deconvoluted to two peaks (see Fig. 10). The position of the peak at the lower temperature is similar to those for 10 and 20-Cu/SiO₂, suggesting presence of fine CuO particles before the reduction. In actual, a small and broad peak attributed to Cu₂O is present in the XRD pattern for 30-Cu/SiO₂ after the reaction. On the basis of the hydrogen consumption in the TPR of 50-Cu/SiO₂, it is evaluated that ca. 10% of CuO is reduced at 170 °C and ca. 40% at 200 °C.

Table 3

Estimation of the quantity of copper atoms on the catalyst surface

Catalyst ^a	Surface Cu atom ^b (m mol g ⁻¹)	Cu of fine particles (m mol g ⁻¹)		Cu of large particles (m mol g ⁻¹)	
		Surface	Total	Surface	Total
10-Cu/SiO ₂	0.4	0.8	1.6	0	0
20-Cu/SiO ₂	1.5	1.7	3.1	0	0
30-Cu/SiO ₂	0.9	1.3	2.9	0.07	1.8
40-Cu/SiO ₂	1.5	1.4	3.1	0.14	3.1
40-Cu/SiO ₂ ^c	1.0	1.7	3.1	0.12	3.1
40-Cu/SiO ₂ ^d	0.9	1.7	3.1	0.12	3.1
50-Cu/SiO ₂	0.4	0.9	3.0	0.17	4.9

^a Reduced with hydrogen at 250 °C except otherwise mentioned.^b The number of Cu atoms on the catalyst surface after the reaction at 250 °C.^c Reduced with hydrogen at 300 °C.^d Reduced with hydrogen at 400 °C.

However, the intensity of the XRD peaks attributed to large Cu particles is small (see Fig. 11). The reducibilities determined by the Rietveld analysis on the XRD in Fig. 11b and c are 4% at 170 °C and 15% at 200 °C, showing that reduction of the large CuO particles mainly takes place above 200 °C. Hence, the TPR peak deconvoluted at the lower temperature can be attributed to the reduction of the fine CuO particles, which are undetectable by XRD. The amounts of copper in the fine and the large particles in Cu/SiO₂ are estimated from the Cu content and the peak areas in the TPR profile assuming complete reduction in the TPR experiment (see Table 3). It is noteworthy that the total quantity of the large Cu particles in the table relates roughly to the peak intensity of the XPD peak attributed to metallic copper (see Fig. 4). On the basis of the TPR result, the atomic ratios of the fine CuO particles to the large ones are calculated as 1.6, 1.0, and 0.6 for 30-, 40-, and 50-Cu/SiO₂, respectively. The values are significantly larger than the atomic Cu ratios of Cu₂O to Cu metal determined by the Rietveld analysis on the XRD in Fig. 4 (0.3, 0.3, and 0.07, respectively). Hence, a large part of the fine particles is probably undetectable by the XRD measurement, while a part of the fine particles is detected as Cu₂O after the reaction.

Assuming that all the large Cu particles in 30-Cu/SiO₂ are in spherical shape with a diameter of 34 nm and that the site density of Cu is 0.032 m mol m⁻² on the basis of the atomic radius, the number of Cu atoms on the surface of the large Cu particles will be only 0.07 m mol g⁻¹ (the density of Cu is 8.9 g cm⁻³). In the cases of silica-supported catalysts prepared by the sol–gel technique, the major part of supported metallic particles is often encapsulated in the bulk [7,17]. Thus, the Cu number on the metallic particle surface should be considerably larger than that of the Cu particles actually exposed on the catalyst surface.

The number of Cu atoms on the catalyst surface after the reaction can be roughly estimated from the surface atomic composition in Table 2 and the BET surface area in Table 1, assuming the site densities of Cu⁺ as 0.058 m mol m⁻², Si⁴⁺ as 0.35 m mol m⁻², and O²⁻ as 0.030 m mol m⁻² on the basis of the ionic radii (Table 3). The value for 30-Cu/SiO₂ after the reaction is calculated as 0.9 m mol g⁻¹. Although the number of Cu atoms on the surface of the metallic Cu particles is calculated on the assumption that all the Cu particles are on the surface, the number is significantly smaller than the number of Cu atoms on the catalyst surface determined by XPS. In addition, the quantity of the fine particles is similar to that for 20-Cu/SiO₂ whose number of the surface Cu atoms determined by XPS is as high as 1.5 m mol g⁻¹ (see Table 3). Thus, it is considered that the information of the Cu 2p_{3/2} and Cu L₃VV in the XPS for 30-Cu/SiO₂ originates mainly from the fine particles which are partly detected as Cu₂O by XRD. In other words, the surface state of the large Cu particles is unknown by the XPS analysis. Since the α value suggests that the major

surface species are present as Cu⁺ (see Table 2), the XRD-invisible fine particles are also estimated to be Cu₂O after the reaction; that is, the mean crystallite size of the fine Cu₂O particles is considerably smaller than that determined by XRD.

The number of Cu⁺ on the fine particle surface can be calculated as 1.3 m mol g⁻¹, assuming that all the fine particles in 30-Cu/SiO₂ are Cu₂O in spherical shape with a diameter of 5 nm and that the site densities of Cu⁺ and O²⁻ are 0.058 and 0.030 m mol m⁻², respectively; the density of Cu₂O is 5.9 g cm⁻³. The Cu⁺ number is probably underestimated due to the presence of the undetectable fine Cu₂O particles, while a significant part of the particles are buried in the bulk.

The tendency of the Cu particle distribution on 40-Cu/SiO₂ is similar to that on 30-Cu/SiO₂, but the number of Cu atoms on the surface of 50-Cu/SiO₂ is fairly small and it is comparable to that of the Cu atoms on the surface of the large Cu particles (see Table 3). Hence, a certain part of the Cu atoms on the surface of 50-Cu/SiO₂ should belong to the metallic particles. In actual, the binding energy of Cu 2p for 50-Cu/SiO₂ is discernibly lower than those for 20, 30, and 40-Cu/SiO₂ in which the major part of the Cu atoms on the surface belong to the fine Cu₂O particles (see Table 2), suggesting presence of the different Cu species from those of the fine Cu₂O particles. However, the α value of 1849.5 eV for 50-Cu/SiO₂ is close to that for Cu₂O [15], implying that the surface of the large metallic particles is also oxidized to Cu⁺ during the reaction.

4.2. Activity of Cu/SiO₂

The catalytic activity of Cu/SiO₂ prepared by the sol–gel method increases with the Cu content up to 40 wt.%. The TPR result shows that the quantities of the fine particles (Cu₂O after the reaction) in 30- and 40-Cu/SiO₂ are similar to that in 20-Cu/SiO₂ (see Table 3). It is reported that Cu₂O supported on zirconium oxide is active to methanol steam reforming [18]. However, the activities of the former two catalysts are significantly higher than that of the latter. Hence, it is supposed that the large metallic Cu particles contribute significantly to the reaction although the number of Cu exposed on the surface is small. The decrease in the activity of 50-Cu/SiO₂ can be accounted for the decrease in the surface area of the fine Cu₂O particles due to the increase in the particle size.

4.3. Mechanism of CO formation

The mechanism of CO formation in the methanol steam reforming has been discussed by some authors [4,19–21]. Although the direct CO formation by methanol decomposition followed by the water–gas shift reaction (WGS) has been proposed [19,20], the CO selectivities in our experiments are significantly smaller than those expected from the reaction equilibrium of WGS;

that is, the equilibrium selectivities will be 2.2% at 250 °C with the methanol conversion of 60% under the experimental conditions and 10.6% at 300 °C with the conversion of 100%. Hence, the direct CO formation is not a major reaction path of the steam reforming over Cu/SiO₂. Formation of methyl formate decomposed to hydrogen and carbon dioxide has been proposed as the reaction mechanism on Cu/SiO₂ [22]. Formation of carbon monoxide by the decomposition of methyl formate may be possible [23,24]; in the mechanism, the CO selectivity will not be greatly affected by the methanol conversion because the CO₂ and CO formation processes are parallel in the decomposition of methyl formate [24]. However, our experimental data show that the CO selectivity increases with an increase in the contact time, and this is in accordance with the kinetic analysis carried out by Purnama et al. in which CO formation is caused by the reverse WGS [21].

A mechanism for the reverse WGS has been proposed on copper catalysts, that is, $\text{CO}_2 + 2\text{Cu} \rightarrow \text{CO} + \text{Cu}_2\text{O}$ and $\text{H}_2 + \text{Cu}_2\text{O} \rightarrow \text{H}_2\text{O} + 2\text{Cu}$ [25]. The mechanism shows that the reaction hardly proceeds over Cu₂O surface in the presence of steam and the high reactivity of Cu with steam to Cu₂O may prevent CO formation. This is in agreement with the report of Ritzkopf et al. that a zirconia-supported copper catalyst gives low selectivity to carbon monoxide in methanol steam reforming and the copper surface is oxidized to Cu⁺ state during the reaction [26]. The presence of Cu₂O particles on Cu/SiO₂ after the reaction evidences oxidation of copper particles with steam during the reaction. On the surface of the large metallic particles, the partial oxidation of copper is hypothesized to take place as suggested by the XPS analysis with 50-Cu/SiO₂. Hence, the generally low CO selectivity on the Cu/SiO₂ catalysts may be due to the formation of Cu⁺ species on the surface during the reaction.

The CO selectivity of 40-Cu/SiO₂ was decreased by the pre-reduction at 300 or 400 °C, showing that CO formation is very small both on the fine Cu₂O and large metallic particles in the catalyst. Although the atomic surface concentration of copper in 40-Cu/SiO₂ pre-reduced at 300 or 400 °C is smaller than that for the catalyst pre-reduced at 250 °C, no significant changes in the binding energy of Cu 2p and the kinetic energy of Cu L₃VV were detected (see Table 2). Hence, presence of special active sites for CO generation is suspected on 40-Cu/SiO₂ reduced at 250 °C and the sites may be deactivated by the reduction at 300 or 400 °C. In other words, the control factor of the CO selectivity is not simply accounted for the presence of the Cu⁺ species on the catalyst surface. The identification of the sites for CO production is difficult even in 10 and 50-Cu/SiO₂, whose CO selectivities are relatively high, because such sites are still minor species on the catalysts.

When the reaction temperature is 300 °C, the CO selectivity is significantly higher than that at 250 °C. Reduction of Cu⁺ to metal easily takes place at a high reaction temperature and it may enhance formation of CO, indicating that stabilization of Cu⁺

species during the reaction will be important for the suppression of CO formation at 300 °C.

5. Conclusions

Selective methanol steam reforming to hydrogen and carbon dioxide proceeds at 250 °C over silica-supported copper prepared by a sol–gel method. When the copper content is 20 wt.% or less, copper particles are highly dispersed and oxidized to Cu₂O with the mean crystallite size less than 4 nm after the reaction. Large metallic copper particles with the mean crystallite size of 30–40 nm coexist with the fine Cu₂O particles in the catalyst containing 30–50 wt.% of copper after the reaction. The activity of the metallic copper particles is supposed to be higher than that of the Cu₂O particles, because the surface area of the former is significantly smaller than that of the latter. The surface of the large metallic particles is estimated to be also oxidized to Cu⁺ in the reaction at 250 °C. The presence of the Cu⁺ species on the catalyst surface may suppress the formation of carbon monoxide by the reverse water–gas shift reaction.

References

- [1] P. Marques, N.F.P. Ribeiro, M. Schmal, D.A.G. Aranda, M.M.V.M. Souza, *J. Power Sources* 158 (2006) 504.
- [2] C. Song, in: N. Brandon, D. Thompson (Eds.), *Fuel Cells Compendium*, Elsevier, Oxford, 2005, p. 53.
- [3] A. Basile, G.F. Tereschenko, N.V. Orekhova, M.M. Ermilova, F. Gallucci, A. Iulianelli, *Int. J. Hydrogen Energy* 31 (2006) 1615.
- [4] J. Agrell, H. Birgersson, M. Boutonnet, *J. Power Sources* 106 (2002) 249.
- [5] N. Takezawa, H. Kobayashi, A. Hirose, M. Shimokawabe, K. Takahashi, *Appl. Catal.* 4 (1982) 127.
- [6] E.G.M. Kuijpers, R.B. Tjepkema, W.J.J. van der Wal, C.M.A.M. Mesters, S.F.G.M. Spronck, J.W. Geus, *Appl. Catal.* 25 (1986) 139.
- [7] Z. Wang, Q. Liu, J. Yu, T. Wu, G. Wang, *Appl. Catal. A* 239 (2003) 87.
- [8] Y.-M. Lin, M.-H. Rei, *Catal. Today* 67 (2001) 77.
- [9] F. Izumi, T. Ikeda, *Mater. Sci. Forum* 321–324 (2000) 198.
- [10] ISO 18118 (2004).
- [11] JCPDS Files, 40836, 50667, and 410254.
- [12] C. Hammond, *The Basics of Crystallography and Diffraction*, Oxford University Press, New York, 1997, p. 145.
- [13] J.W.E. Coenen, *Appl. Catal.* 75 (1991) 193.
- [14] Y. Matsumura, K. Kuraoka, T. Yazawa, M. Haruta, *Catal. Today* 45 (1998) 191.
- [15] C.D. Wagner, *Practical surface analysis*, in: D. Briggs, M.P. Seah (Eds.), second edition, *Auger and X-ray Photoelectron Spectroscopy*, vol. 1, John Wiley & Sons, Inc., New York, 1990, p. 595.
- [16] Y. Matsumura, T. Nakamori, *Appl. Catal. A* 258 (2004) 107.
- [17] Y. Matsumura, N. Tode, T. Yazawa, M. Haruta, *J. Mol. Catal. A* 99 (1995) 183.
- [18] H. Oguchi, H. Kanai, K. Utani, Y. Matsumura, S. Imamura, *Appl. Catal. A* 293 (2005) 64.
- [19] E. Santacesaria, S. Carrà, *Appl. Catal.* 5 (1983) 345.
- [20] B.A. Peppley, J.C. Amphlett, L.M. Kearns, R.F. Mann, *Appl. Catal. A* 179 (1999) 31.
- [21] H. Purnama, T. Ressler, R.E. Jentoft, H. Soerijanto, R. Schlögl, R. Schomäcker, *Appl. Catal. A* 259 (2004) 83.
- [22] K. Takahashi, N. Takezawa, H. Kobayashi, *Appl. Catal.* 2 (1982) 363.
- [23] T.P. Minyukova, I.I. Simentsova, A.V. Khasin, N.V. Shtertser, N.A. Baronskaya, A.A. Khassin, T.M. Yurieva, *Appl. Catal. A* 237 (2002) 171.
- [24] Y. Choi, H.G. Stenger, *Appl. Catal. B* 38 (2002) 259.
- [25] M.J.L. Ginés, A.J. Marchi, C.R. Apesteguía, *Appl. Catal. A* 154 (1997) 155.
- [26] I. Ritzkopf, S. Vukojević, C. Weidenthaler, J.-D. Grunwaldt, F. Schüth, *Appl. Catal. A* 302 (2006) 215.